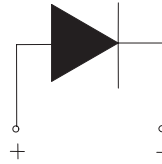
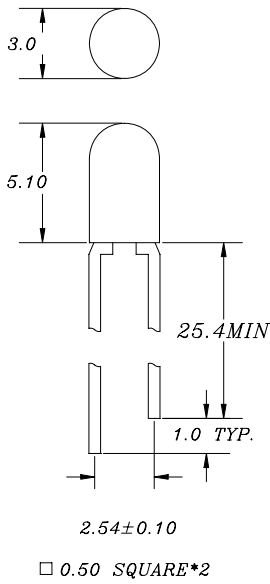


Package Dimensions



- Notes: 1. All dimensions are in millimeters (inches).
 2. Tolerance is $\pm 0.25\text{mm}$ (.010") unless otherwise noted.
 3. Protruded resin under flange is 1.0mm (.04") max.
 4. Lead spacing is measured where the leads emerge from the package.
 5. Specifications are subject to change without notice.

Absolute Maximum Ratings at $T_a=25^\circ\text{C}$

Electrical / Optical Characteristics at $T_a=25^\circ\text{C}$

Parameter	Maximum Rating	Unit
Power Dissipation	100	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	100	mA
Continuous Forward Current	35	mA
Reverse Voltage	5	V
Operating Temperature Range	-30°C to + 80°C	
Storage Temperature Range	-40°C to + 100°C	
Lead Soldering Temperature [4mm(.157") From Body]	280°C for 5 Seconds	

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity	I_V	310	600		mcd	$I_F = 20\text{mA}$
Viewing Angle	$2\theta_{1/2}$		45		deg	$I_F = 20\text{mA}$
Peak Emission Wavelength	λ_p		590		nm	$I_F = 20\text{mA}$
Dominant Wavelength	λ_d	584	589	594	nm	$I_F = 20\text{mA}$
Spectral Line Half-Width	$\Delta\lambda$		20		nm	$I_F = 20\text{mA}$
Forward Voltage	V_F		2.0	2.5	V	$I_F = 20\text{mA}$
Reverse Current	I_R			10	μA	$V_R = 5\text{V}$

TYPICAL ELECTRON-OPTICAL CHARACTERISTIC CURVES
25°C Free Air Temperature Unless Otherwise Specified

